



DMN2028UFU

Product Summary

V _{(BR)DSS}	R _{DS} (ON) Max	Ι _D T _A = +25°C
20V	$20.2m\Omega @ V_{GS} = 4.5V$	7.5A
	$23.5 \text{m}\Omega @ \text{V}_{\text{GS}} = 2.5 \text{V}$	7.0A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Power Management Functions
- Battery Pack
- Load Switch

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: U-DFN2030-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.012 grams (Approximate)

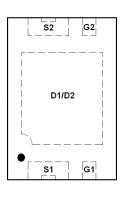


ESD PROTECTER

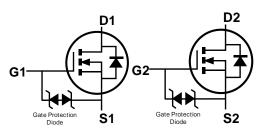


U-DFN2030-6

Bottom View



Top View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2028UFU-7	U-DFN2030-6	3000 / Tape & Reel
DMN2028UFU-13	U-DFN2030-6	10000 / Tape & Reel

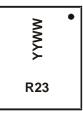
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



R23 = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 14 for 2014) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±10	V
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$	Steady State	T _A = +25°C T _A = +70°C	ID	7.5 6.0	A
	t<10s	T _A = +25°C T _A = +70°C	Ι _D	9.9 7.9	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	40	A
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	12	А
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	8	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	0.9	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	144	°C/W	
memai Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ extsf{ heta}JA}$	84	C/VV	
Total Power Dissipation (Note 6)	T _A = +25°C	PD	1.8	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	5	69	°C/W	
memai Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ heta JA}$	40		
Thermal Resistance, Junction to Case		$R_{ ext{ heta}JC}$	8.4		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)						·	
Drain-Source Breakdown Voltage	BV _{DSS}	20		—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	—		1	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	—		±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	0.5	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
			15.3	20.2		$V_{GS} = 4.5 V, I_D = 4.5 A$	
			15.4	22.5		$V_{GS} = 4.0V, I_D = 4.0A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	16.7	23.0	mΩ	$V_{GS} = 3.1 V$, $I_D = 4.0 A$	
			18.3	23.5		$V_{GS} = 2.5V, I_D = 3.5A$	
			24.2	30.0		V _{GS} = 1.8V, I _D = 3.5A	
Diode Forward Voltage	V _{SD}	—	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	—	887	—			
Output Capacitance	C _{oss}	—	91	—	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	—	37	—		1 = 1.000112	
Gate Resistance	Rg	—	191	—	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	10	—			
Total Gate Charge (V _{GS} = 8V)	Qg	—	18.4	—	nC	10/1 0.54	
Gate-Source Charge	Q _{gs}	—	1.3	—	nc	$V_{DS} = 10V, I_D = 6.5A$	
Gate-Drain Charge	Q _{gd}	—	1.8	—			
Turn-On Delay Time	t _{D(ON)}	_	53	_			
Turn-On Rise Time	t _R	—	66	—		$\label{eq:VDS} \begin{split} V_{DS} &= 10V, V_{GS} = 4.5V, \\ R_G &= 6\Omega, R_L = 10\Omega, I_D = 1A \end{split}$	
Turn-Off Delay Time	t _{D(OFF)}	_	619		ns		
Turn-Off Fall Time	t _F	—	197	—			
Reverse Recovery Time	t _{RR}	_	119	_	ns	I _F = 4A, di/dt = 100A/µs	
Reverse Recovery Charge	Q _{RR}		96	—	nC	$I_{\rm F} = 4$ A, di/dt = 100A/µs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

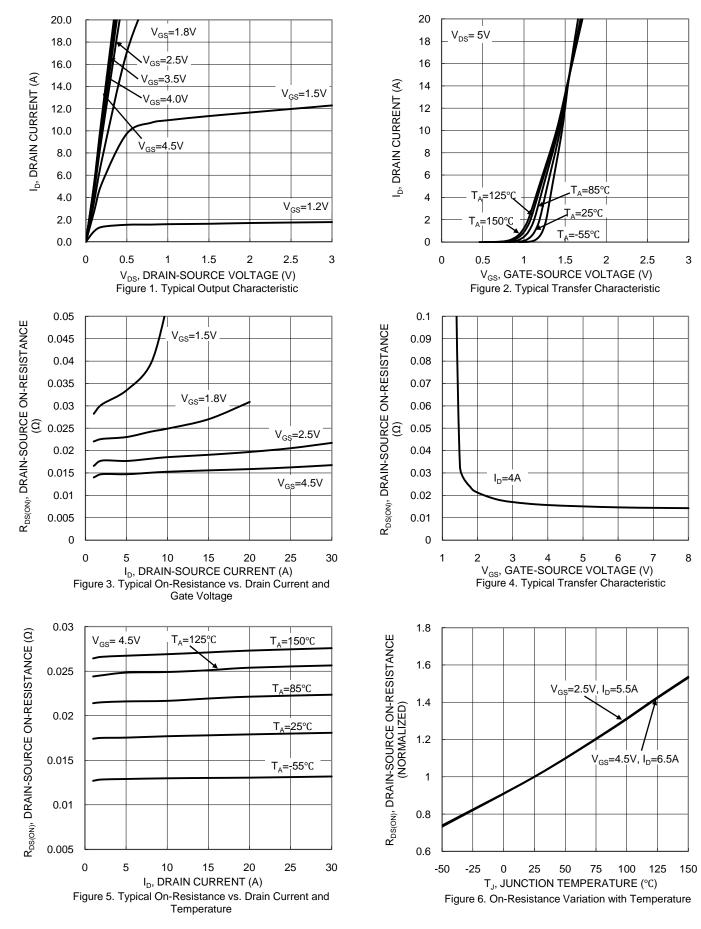
7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



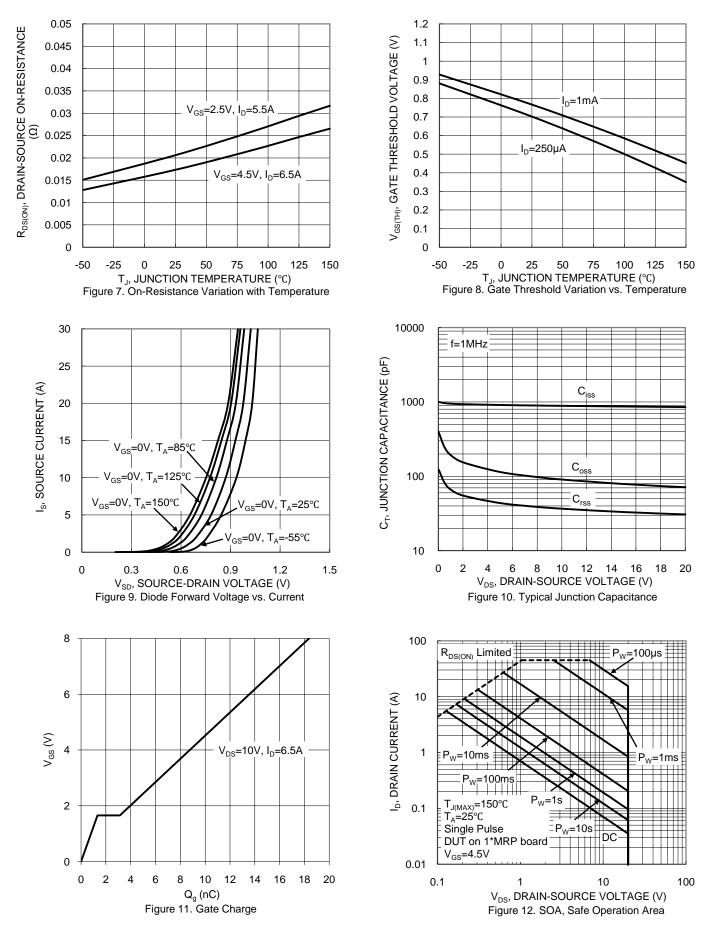
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NEW PRODUCT

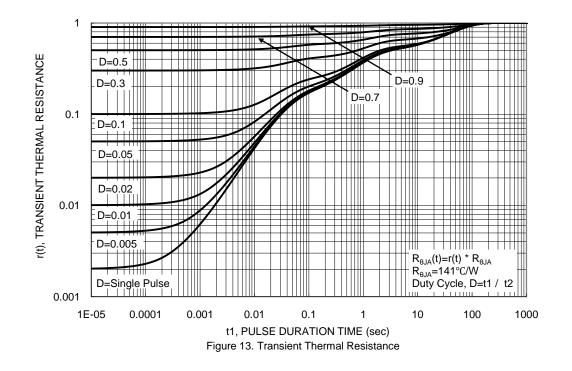
DMN2028UFU Document number: DS37945 Rev. 1 - 2





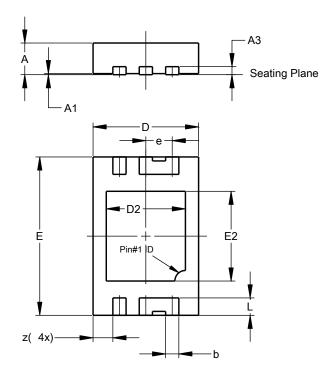
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Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

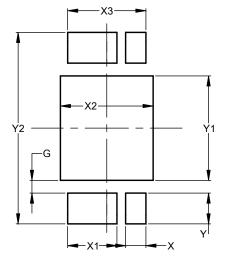


U-DFN2030-6 (Type B)					
Dim	Min	Max	Тур		
Α	0.55	0.65	0.60		
A1	0.00	0.05	0.02		
A3			0.15		
b	0.20	0.30	0.25		
D	1.95	2.05	2.00		
D2	1.40	1.60	1.50		
Е	2.95	3.05	3.00		
E2	1.65	1.75	1.70		
е			0.50		
L	0.28	0.38	0.33		
z			0.375		
All Dimensions in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
G	0.220		
Х	0.350		
X1	0.850		
X2	1.600		
X3	1.350		
Y	0.530		
Y1	1.800		
Y2	3.300		

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